



TECHNICAL REPORT

**Communication networks and systems for power utility automation -
Part 80-5: Guideline for mapping information between IEC 61850 and IEC 61158-15**

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INTERNATIONAL ELECTROTECHNICAL COMMISSION

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between IEC 61850 and IEC 61158-15**

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IEC TR 61850-80-5 has been prepared by IEC technical committee 57: Power systems management and associated information exchange. It is a Technical Report.

This second edition cancels and replaces the first edition published in 2024. This edition constitutes a technical revision.

This edition includes the following significant technical changes with respect to the previous edition:

- a) deficiencies / missing text in Edition 1 corrected.

The text of this Technical Report is based on the following documents:

Draft	Report on voting
57/2858/DTR	57/2891/RVDTR

Full information on the voting for its approval can be found in the report on voting indicated in the above table.

The language used for the development of this Technical Report is English.

This document was drafted in accordance with ISO/IEC Directives, Part 2, and developed in accordance with ISO/IEC Directives, Part 1 and ISO/IEC Directives, IEC Supplement, available at www.iec.ch/members_experts/refdocs. The main document types developed by IEC are described in greater detail at www.iec.ch/standardsdev/publications.

A list of all parts in the IEC 61850 series, published under the general title *Communication networks and systems for power utility automation*, can be found on the IEC website.

NOTE The following print types are used:

- *specific element names from the SCL extension: in italic type.*

This IEC standard includes Code Components i.e. components that are intended to be directly processed by a computer. Such content is any text found between the markers <CODE BEGINS> and <CODE ENDS>, or otherwise is clearly labeled in this standard as a Code Component.

The purchase of this IEC standard carries a copyright license for the purchaser to sell software containing Code Components from this standard directly to end users and to end users via distributors, subject to IEC software licensing conditions, which can be found at: <http://www.iec.ch/CCv1>.

The committee has decided that the contents of this document will remain unchanged until the stability date indicated on the IEC website under webstore.iec.ch in the data related to the specific document. At this date, the document will be

- reconfirmed,
- withdrawn, or
- revised.

INTRODUCTION

This part of IEC 61850, which is a Technical Report, provides a guideline to exchanging information between IEC 61850 and IEC 61158-6-15 (Modbus TCP). Today, industrial fields, such as distributed energy resource (wind and solar energy, etc.) and condition monitoring, have been successfully exchanging information from Modbus to IEC 61850. Although many manufacturers have already implemented the Modbus to IEC 61850 conversion device or system, these devices do not guarantee interoperability. Therefore, a consistent and unified information exchange scheme between IEC 61850 and IEC 61158-6-15 is required.

Modbus over serial line (Modbus RTU) is not part of IEC 61158-6-15 but is also considered in this technical report.

It was first foreseen to prepare this document as a Technical Specification. However, as there is a lack of feedback from practical experience, it was decided to first publish a Technical Report with a limited scope (see 57/2506/Q and 57/2553/RQ).

This is now the second edition of a Technical Report with the scope including the mapping of a Modbus device's command from an IEC 61850 model.

1 Scope

1.1 General

1.1.1 Scope statement

This part of IEC 61850, which is a Technical Report, specifies the mapping framework for building and configuring a system using both IEC 61850 and IEC 61158-6-15 (Industrial communication networks – Fieldbus specification, CPF Type 15, Modbus) protocols by utilizing gateways between IEC 61850 and IEC 61158-6-15 IEDs / subsystems. The objective is to enable operational run-time data exchange among these IEDs / subsystems, and to automate the configuration of a gateway as much as possible.

Please note that for the purposes of this document, "Modbus" is used to represent both serial Modbus (Modbus RTU) and IEC 61158-6-15 (Modbus TCP).

Within the capability of each protocol, some configuration attributes (IEC 61850-7-3:2010 and IEC 61850-7-3:2010/AMD1:2020 attributes with functional constraint CF) are also mapped in addition to the operational real-time data.

The frameworks specified in this document are based on the published standards and do not make any proposed changes to IEC 61850 or 61158-6-15. This standard does not specify any framework for an IEC 61850 IED to directly communicate with a Modbus IED and vice versa, except through a gateway.

This document does not mandate which data items that a particular IED will be supporting, regardless of whether the implementation uses Modbus or IEC 61850. Instead, this document provides a framework specifying how a gateway maps any given data item from Modbus into an IEC 61850 substation, including the control direction.

Similarly, this document does not mandate which mapping framework a given gateway will be supporting. When this document is republished as a Technical Specification, conformance requirements will be identified.

This document recognizes that there will be situations in which a user will require that a gateway perform non-standard protocol mappings. Non-standard mappings are outside the scope of this document.

This document also recognizes that gateways typically manipulate the data passing through them in a variety of ways. Some of these functions include alarm trigger grouping, data suppression, interlocking and command blocking. Conformance to this document does not preclude a gateway from performing such functions, even though this document primarily specifies "straight through" mapping of Modbus data to IEC 61850-7-3:2010 and IEC 61850-7-3:2010/AMD1:2020 data. Subclause 7.5 of this document describes how some of these functions can be specified to a gateway by a mapping tool using XML representations of conversion functions.

The mapping architecture for the exchange of the run-time information consists of four parts:

- a) Conceptual architecture of a gateway and associated use case
- b) Mapping of the information model (Assign semantic to the Modbus data)
- c) Mapping of the data (which is in fact part of the information model)
- d) Mapping of the services (out of scope for this document)

1.1.2 Areas of application

While a primary focus of this document is for electric utility industry, other industries that deliver energy and water could also use this document if they also plan to use both Modbus and IEC 61850 in their systems.

Vendors can use this document to implement and test their gateway products and be assured of their interoperability to this mapping standard. Users can use this document to specify their respective systems. System integrators can use this standard to assist in system integration and testing of user systems utilizing both protocols and gateways.

Modbus device vendors can use this document to express, in a non-ambiguous manner, the semantics of each of the data points exposed over the Modbus interface.

1.1.3 Benefits

This document specifies an SCL extension, using a Modbus specific XML namespace, to add syntax for describing the mapping of Modbus data into the IEC 61850 data model (see Annex A for use of SCL to include Modbus information). By using this specification, Modbus devices can benefit from the full IEC 61850 ecosystem (engineering tools, engineering process, functional naming, ...).

This version of the document describes the mapping of data from a Modbus server to be exposed in an IEC 61850 server access point of the gateway. This is intended to enable automated gateway configuration.

1.2 Published versions of this standard and related namespace name

Table 1 provides an overview of the references between the published versions of this standard and the related namespace name.

Table 1 – Reference between published versions of the standard and related namespace name

Edition	Publication date	Webstore	Namespace
Edition 1.0	2024-02	IEC TR 61850-80-5:2024	IEC 61850-80-5:2020A2
Edition 2.0	2025-xx	IEC TR 61850-80-5:2025	IEC 61850-80-5:2020A4

1.3 Namespace name and version

The namespace associated with this document is an XML schema (XSD) for an extension to the System Configuration Language (SCL) as defined in IEC 61850-6. The parameters which are identifying the namespace are provided in Table 2.

Table 2 – Attributes of IEC 61850-80-5 XML namespace

Attribute	Content
Namespace nameplate	
Namespace Identifier (xmlns)	http://www.iec.ch/61850/2020/SCL/80-5
Version	2020
Revision	A
Release	4
XSD version header attribute	2020A4
Recommended reference name	eIEC61850-80-5
CodeComponentName	IEC_61850-80-5.SCL.2020A4.Full
Namespace dependencies	
includes	http://www.iec.ch/61850/2003/SCL version :2007 revision :B release :4

1.4 Code Component distribution

Each Code Component is a ZIP package containing at least the electronic representation of the Code Component itself and a file describing the content of the package (IECManifest.xml).

The life cycle of a code component is not restricted to the life cycle of the related publication. The publication life cycle goes through two stages, Version (corresponding to an edition) and Revision (corresponding to an amendment). A third publication stage (Release) allows publication of Code Component in case of urgent fixes of InterOp Tissues, thus without need to publish an amendment.

Consequently, new release(s) of the Code Component might be released, which supersede(s) the previous release, and will be distributed through the IEC TC57 web site at:

<http://www.iec.ch/tc57/supportdocuments>.

The latest version/release of the document will be found by selecting the file for the code component with the highest value for VersionStateInfo, e.g. IEC_TR_61850-80-5.SCL.{VersionStateInfo}.full.zip.

The code component associated to this document is an XML schema file (XSD). It is available as a full version only. It is freely accessible on the IEC website for download at <http://www.iec.ch/tc57/supportdocuments> but the usage remains under the licensing conditions.

In case of any differences between the downloadable code component and the IEC pdf published content, the downloadable code component is the valid one; it can be subject to updates. See included history files.

2 Normative references

There are no normative references in this document.

Bibliography

IEC 61158-1, *Industrial communication networks - Fieldbus specifications - Part 1: Overview and guidance for the IEC 61158 and IEC 61784 series*

IEC 61158-5-15, *Industrial communication networks - Fieldbus specifications - Part 5-15: Application layer service definition - Type 15 elements*

IEC 61158-6-15, *Industrial communication networks - Fieldbus specifications - Part 6-15: Application layer protocol specification - Type 15 elements*

IEC 61784-1, *Industrial networks - Profiles - Part 1: Fieldbus profiles*

IEC 61784-5-15, *Industrial communication networks - Profiles - Part 5-15: Installation of fieldbuses - Installation profiles for CPF 15*

IEC TS 61850-2:2019, *Communication networks and systems for power utility automation - Part 2: Glossary*

IEC 61850-6, *Communication networks and systems for power utility automation - Part 6: Configuration description language for communication in electrical substations related to IEDs*

IEC 61850-7-1, *Communication networks and systems for power utility automation - Part 7-1: Basic communication structure - Principles and models*

IEC 61850-7-2:2010, *Communication networks and systems for power utility automation - Part 7-2: Basic information and communication structure - Abstract communication service interface (ACSI)*

IEC 61850-7-2:2010/AMD1:2020

IEC 61850-7-3:2010, *Communication networks and systems for power utility automation - Part 7-3: Basic communication structure - Common data classes*

IEC 61850-7-3:2010/AMD1:2020

IEC 61850-7-4:2010, *Communication networks and systems for power utility automation - Part 7-4: Basic communication structure - Compatible logical node classes and data object classes*

IEC 61850-7-4:2010/AMD1:2020

IEC 61784-2:2019, *Industrial communication networks - Profiles - Part 2: Additional fieldbus profiles for real-time networks based on ISO/IEC/IEEE 8802-3*

IEC 61158-5-15:2010, *Industrial communication networks - Fieldbus specifications - Part 5-15: Application layer service definition - Type 15 elements*

IEC 61158-6-15:2010, *Industrial communication networks - Fieldbus specifications - Part 6-15: Application layer protocol specification - Type 15 elements*

IEC 62453-1, *Field device tool (FDT) interface specification - Part 1: Overview and guidance*

IEC 62453-2, *Field device tool (FDT) interface specification - Part 2: Concepts and detailed description*

IEC 62453-315, *Field device tool (FDT) Interface specification - Part 315: Communication profile integration - IEC 61784 CPF 15*

IEC TR 62453-41, *Field device tool (FDT) interface specification - Part 41: Object model integration profile - Common object model*

IEC 62453-515, *Field device tool (FDT) interface specification - Part 515: Communication implementation for common object model - IEC 61784 CPF 15*

IEEE 754, *IEEE Standard for Floating-Point Arithmetic*

Modbus-IDA, Modbus Application Protocol Specification V1.1b, December 28, 2006.

Modicon Modbus Protocol Reference Guide

Modbus Application Protocol Specification

Modbus Messaging on TCP/IP Implementation Guide V1.0b

Conformance test specification for Modbus TCP version 3.0, Modbus Organization, Inc., December 15, 2009
